



Product Change Notification

Change Notification #: 116765 - 00
Change Title: Select Intel® Data Center Blocks for Cloud, MXN2224WFAFL1, MXN1208WFAFM1, MXN1208WFAFS2, MXN1208WFAFS1, MXN2224BPAFH1, PCN 116765-00, Product Discontinuance, End of Life
Date of Publication: February 15, 2019

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Product Discontinuance Program Support Begins:	February 15, 2019
Last Product Discontinuance Order Date:	February 15, 2019
Orders are Non-Cancelable and Non-Returnable After:	February 15, 2019
Last Product Discontinuance Shipment Date:	February 15, 2019

Description of Change to the Customer:

Intel is announcing the discontinuance of the Intel® Data Center Blocks for Cloud, MXN2224WFAFL1, MXN1208WFAFM1, MXN1208WFAFS2, MXN1208WFAFS1, MXN2224BPAFH1 as listed in the "Products Affected/Intel Ordering Codes" table below.

Intel will discontinue builds on the LPDO date. After the LPDO date, existing inventory is still orderable, under NCNR terms, and will be filled on a first come first served basis. Deliveries must be accepted within 90 days from the LPDO date.

Final purchase orders are non-cancelable and non-returnable, notwithstanding any conflicting terms in our quotes, purchase order acknowledgement or Distributor agreements.

Intel reserves the right to change the products because of material source restriction.

1. No new OS, peripheral or adaptor validation is planned during the extended life period. The THOL, supported processor and tested memory lists are frozen at PDA.
2. No new features enhancements should be expected, however ECOs may be required during the extended life period to maintain supply lines (e.g. to qualify new vendor due to a component EOL).
3. Intel will provide reasonable commercial efforts in debugging issues during the warranty period for the product after the PDA date has passed. Fixes cannot be committed, but Intel will endeavor to provide reasonable workarounds for the product.

Customer Impact of Change and Recommended Action:

Determine your remaining demand for this product and/or evaluate additional sources (if applicable).

Lead-times on products with announced product discontinuance can typically stretch to 12 weeks and volumes are not buffered during the PDA period. Please work with your Intel representative on your quarterly demand forecast in order to reduce lead-times to 2-4 Weeks.

Please contact your local Intel Sales Office or Distributor if you require more information or need assistance in selecting a replacement product.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#
Intel® Server System	MXN2224WFAFL1	999CRJ
Intel® Server System	MXN1208WFAFM1	999CRK
Intel® Server System	MXN1208WFAFS2	999CRL
Intel® Server System	MXN1208WFAFS1	999CRM
Intel® Server System	MXN2224BPFAFH1	999CRN

PCN Revision History:

Date of Revision:

February 15, 2019

Revision Number:

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Reason:

Originally Published PCN



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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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